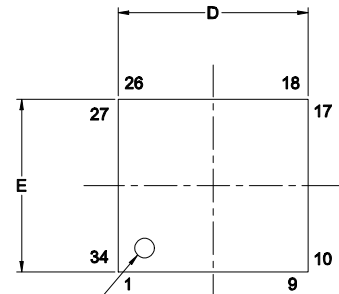
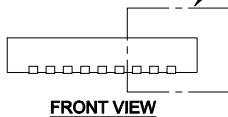


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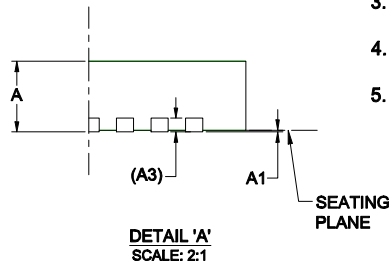
DATE 02 JUL 2021


PIN#1  
INDICATOR

TOP VIEW

SEE  
DETAIL 'A'


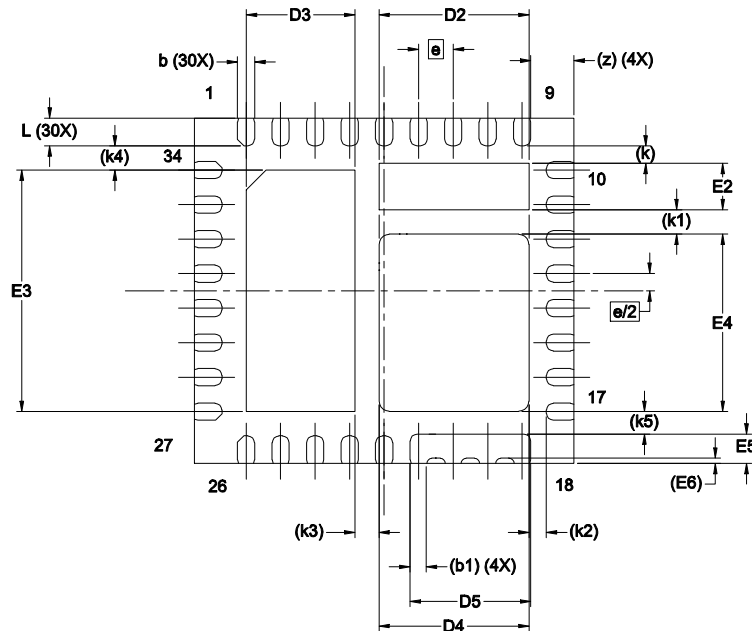
FRONT VIEW


DETAIL 'A'  
SCALE: 2:1

## NOTES:

1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 2009.
2. CONTROLLING DIMENSION: MILLIMETERS
3. COPLANARITY APPLIES TO THE EXPOSED PADS AS WELL AS THE TERMINALS.
4. DIMENSIONS D1 AND E1 DO NOT INCLUDE MOLD FLASH, PROTRUSIONS, OR GATE BURRS.
5. SEATING PLANE IS DEFINED BY THE TERMINALS. "A1" IS DEFINED AS THE DISTANCE FROM THE SEATING PLANE TO THE LOWEST POINT ON THE PACKAGE BODY.

DIM	MILLIMETERS		
	MIN.	NOM.	MAX.
A	0.95	1.05	1.15
A1	0.00	—	0.05
A3	0.20 REF		
b	0.20	0.25	0.30
b1	0.24 REF		
D	5.40	5.50	5.60
D2	2.08	2.18	2.28
D3	1.48	1.58	1.68
D4	2.08	2.18	2.28
D5	1.65	1.75	1.85
E	4.90	5.00	5.10
E2	0.58	0.68	0.78
E3	3.40	3.50	3.60
E4	2.48	2.58	2.68
E5	0.33	0.43	0.53
E6	0.07 REF		
e	0.50 BSC		
e/2	0.25 BSC		
k	0.25 REF		
k1	0.35 REF		
k2	0.25 REF		
k3	0.35 REF		
k4	0.35 REF		
k5	0.33 REF		
L	0.30	0.40	0.50
z	0.63 REF		



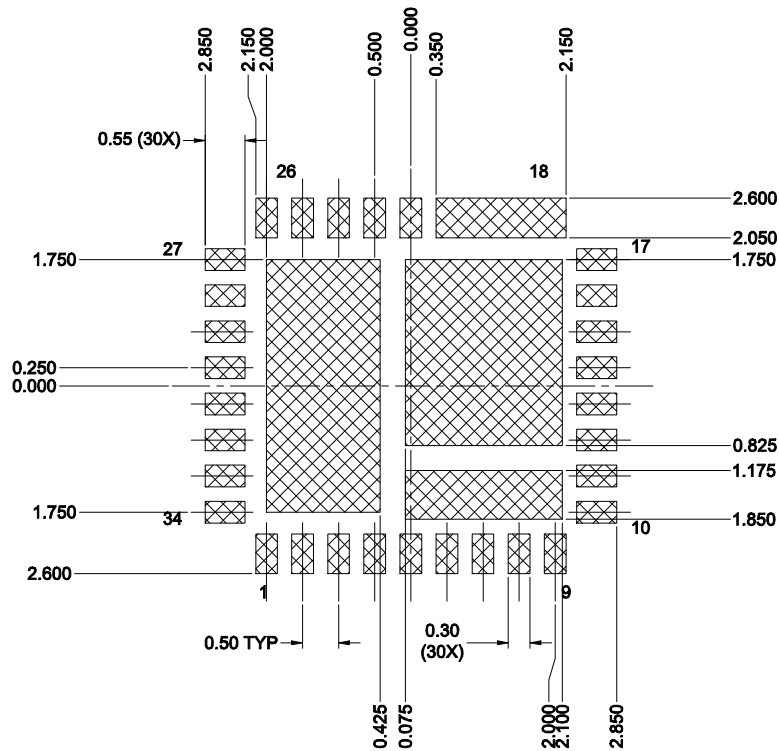
BOTTOM VIEW

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LAND PATTERN  
RECOMMENDATION

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